Features

- Ultra-Small Surface Mount Package
- Very Low Leakage Current
- **Lead Free/RoHS Compliant (Note 1)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **"Green" Device (Notes 2 and 3)**

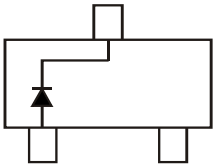
Mechanical Data

- Case: SOT-523
- Case Material: Molded Plastic, “Green” Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking Information: See Diagrams Below and Page 3
- Ordering Information: See Page 2
- Weight: 0.002 grams (approximate)

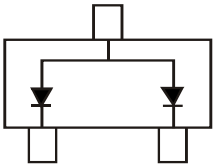
SOT-523



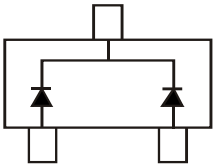
Top View



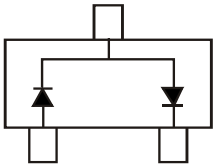
BAS116T Marking: 50



BAW156T Marking: 53



BAV170T Marking: 51



BAV199T Marking: 52

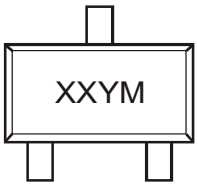
Ordering Information (Note 4)

Part Number*	Case	Packaging
BAS116T-7-F	SOT-523	3000/Tape & Reel
BAS116T-7-F-N	SOT-523	3000/Tape & Reel
BAW156T-7-F	SOT-523	3000/Tape & Reel
BAV170T-7-F	SOT-523	3000/Tape & Reel
BAV170T-7-F-N	SOT-523	3000/Tape & Reel
BAV199T-7-F	SOT-523	3000/Tape & Reel
BAV199T-7-F-N	SOT-523	3000/Tape & Reel

Notes:
1. No purposefully added lead.
2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
3. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb_2O_3 Fire Retardants.
4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

* If products manufactured in a specific region are required, select part numbers with the -N, -V, or -W suffix. These suffixes identify the wafer fabrication and assembly/test locations as defined in our Supply Resiliency information.

Marking Information



XX = Product Type Marking Code (See Page 1, e.g. 50 = BAS116T)
YM = Date Code Marking
Y = Year (ex: N = 2002)
M = Month (ex: 9 = September)
A bar or underline around the date code or product type marking code denotes assembly site if marked.

Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	M	N	P	R	S	T	U	V	W	X	Y	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V_{RRM} V_{RWM} V_R	85	V
RMS Reverse Voltage		$V_{R(RMS)}$	60	V
Forward Continuous Current (Note 5)	Single Diode Double Diode	I_{FM}	215 125	mA
Repetitive Peak Forward Current		I_{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I_{FSM}	4.0 1.0 0.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	150	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	833	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	85	—	—	V	I_R = 100μA
Forward Voltage	V_F	—	—	0.90 1.0 1.1 1.25	V	I_F = 1.0mA I_F = 10mA I_F = 50mA I_F = 150mA
Leakage Current (Note 6)	I_R	—	—	5.0 80	nA nA	V_R = 75V V_R = 75V, T_j = 150°C
Total Capacitance	C_T	—	2	—	pF	V_R = 0, f = 1.0MHz
Reverse Recovery Time	t_{rr}	—	—	3.0	μs	I_F = I_R = 10mA, I_{rr} = 0.1 x I_R, R_L = 100Ω

Notes: 5. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
6. Short duration pulse test used to minimize self-heating effect.

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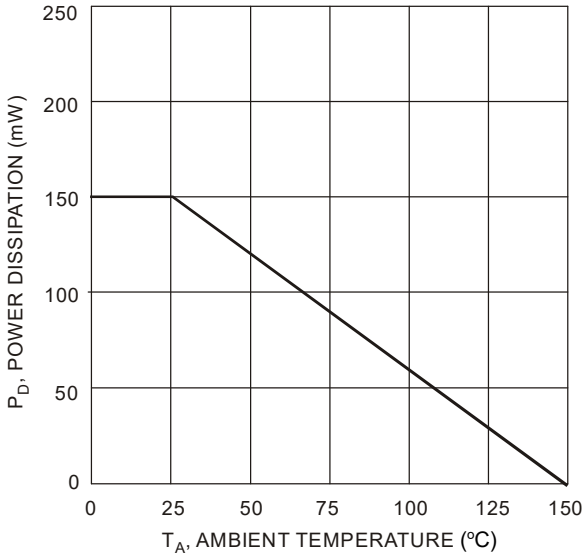


Fig. 1 Power Derating Curve

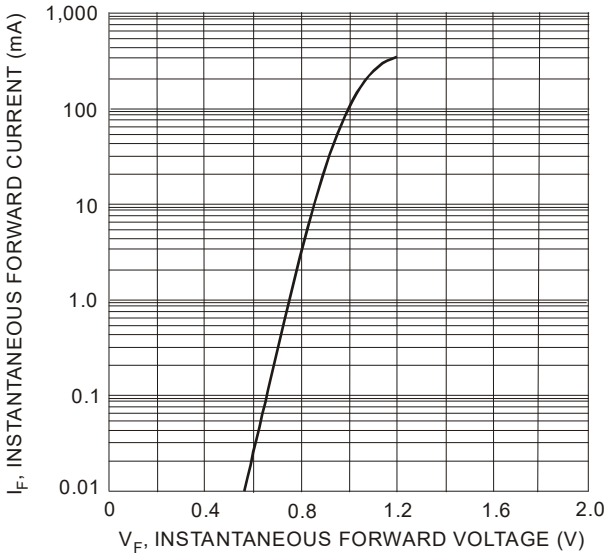


Fig. 2 Typical Forward Characteristics

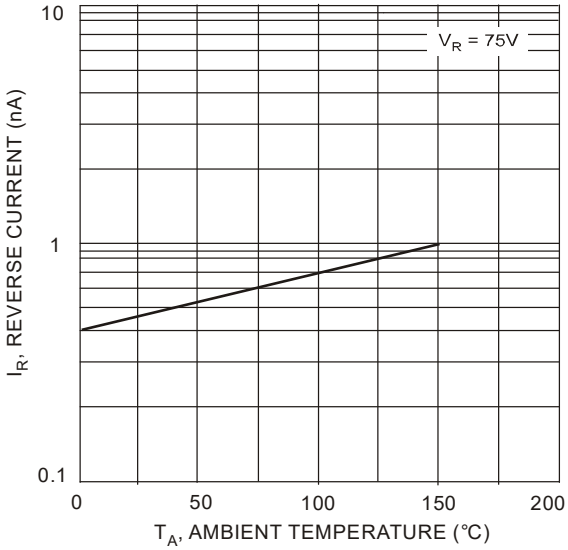


Fig. 3 Typical Reverse Characteristics

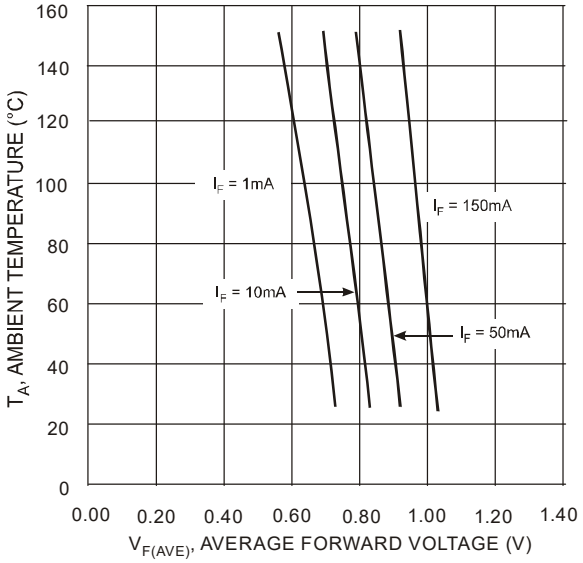
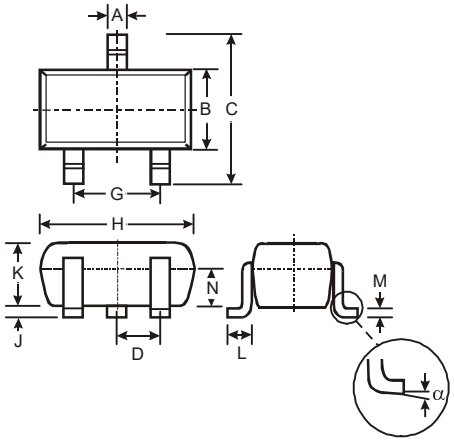


Fig. 4 Typical Forward Voltage vs. Ambient Temperature

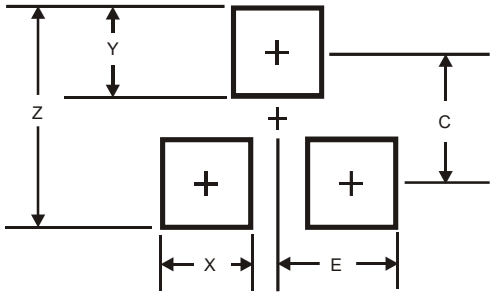
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Package Outline Dimensions



SOT-523			
Dim	**Min**	**Max**	**Typ**
A	0.15	0.30	0.22
B	0.75	0.85	0.80
C	1.45	1.75	1.60
D	—	—	0.50
G	0.90	1.10	1.00
H	1.50	1.70	1.60
J	0.00	0.10	0.05
K	0.60	0.80	0.75
L	0.10	0.30	0.22
M	0.10	0.20	0.12
N	0.45	0.65	0.50
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
X	0.4
Y	0.51
C	1.3
E	0.7

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